

ABSTRACT OF THE DISCLOSURE

METHOD FOR CUTTING GLASS LAMINATE

BACKGROUND OF THE INVENTION

Disclosed herein is a method for cutting a glass laminate including first and second glass plates, which includes: a first scribing step of forming a first scribe line on the surface of the first glass plate; an additional etching step of bringing the glass laminate into contact with an etchant to reduce the thickness of the entire glass laminate; a second scribing step of forming a second scribe line as a counterpart of the first scribe line on the surface of the second glass plate of the glass laminate whose thickness has been reduced, and a cutting step of applying stress to the glass laminate to cut the glass laminate along the scribe lines, wherein these steps are performed in this order. In the invention, a glass laminate, in which fractures starting from a scribe line before the cutting of a glass laminate is performed can be suppressed, can be cut.

FIGURE 2